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TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74LCX540F, TC74LCX540FT, TC74LCX540FK

Low-Voltage Octal Bus Buffer (inverted) with 5-V Tolerant Inputs and Outputs

The TC74LCX540 is a high-performance CMOS octal bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

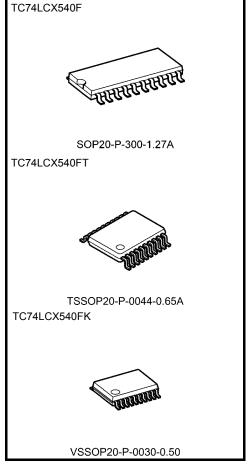
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

The TC74LCX540 is an inverting 3-state buffer having two active-low output enables. When either  $\overline{OE}1$  or  $\overline{OE}2$  are high, the terminal outputs are in the high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

#### **Features**

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation:  $t_{pd} = 6.5 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: >±500 mA
- Available in JEITA SOP, TSSOP and VSSOP (US)
- Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 540 type

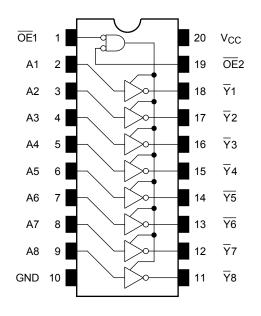


Weight:

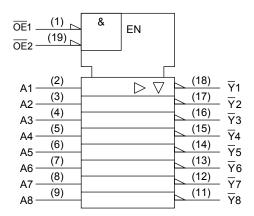
SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

Note: The Electrical Characteristics of  $V_{CC}=1.8\pm0.15V$  is only applicable for products which manufactured from January 2009 onward.

## Pin Assignment (top view)



## **IEC Logic Symbol**



### **Truth Table**

	Inputs					
OE1	OE2	An	Outputs			
Н	Х	Х	Z			
Х	Н	Х	Z			
L	L	Н	L			
L	L	L	Н			

X: Don't care

Z: High impedance



#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Power supply voltage	$V_{CC}$	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	V
Input diode current	ΙΙΚ	-50	mA
Output diode current	I <sub>OK</sub>	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	P <sub>D</sub>	180	mW
DC V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. I<sub>OUT</sub> absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

### **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V <sub>CC</sub>	1.65 to 3.6	٧	
Tower supply voltage	VCC	1.5 to 3.6 (Note 2)		
Input voltage	V <sub>IN</sub>	0 to 5.5	٧	
Output voltage	Vout	0 to 5.5 (Note 3)	٧	
Output voltage		0 to V <sub>CC</sub> (Note 4)		
Output current	lou/lou	±24 (Note 5)	mA	
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±12 (Note 6)	Ш	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either V<sub>CC</sub> or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 7:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



### **Electrical Characteristics**

### DC Characteristics (Ta = -40 to 85°C)

Characteris	Characteristics Symbol Test Condition					Min	Max	Unit
Onaraciens	1103	Cymbol			V <sub>CC</sub> (V)	IVIIII	IVIAX	O I II
					1.65 to 2.3	V <sub>CC</sub> × 0.9	_	
	H-level	V <sub>IH</sub>	_	_		1.7	_	
Input voltage					2.7 to 3.6	2.0	_	V
input voltage					1.65 to 2.3	_	V <sub>CC</sub> × 0.1	v
	L-level	VIL	_	-	2.3 to 2.7	_	0.7	
					2.7 to 3.6	_	0.8	
				I <sub>OH</sub> = -100 μA	1.65 to 3.6	V <sub>CC</sub> -0.2	_	
				I <sub>OH</sub> = -4 mA	1.65	1.05	_	
	l l laval		\ \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	I <sub>OH</sub> = -8 mA	2.3	1.7	_	V
	H-level	V <sub>OH</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OH</sub> = -12 mA	2.7	2.2	_	
				I <sub>OH</sub> = -18 mA	3.0	2.4		
Outrast valta aa				I <sub>OH</sub> = -24 mA	3.0	2.2	_	
Output voltage				I <sub>OL</sub> = 100 μA	1.65 to 3.6	_	0.2	
				I <sub>OL</sub> = 4 mA	1.65	_	0.45	
	Lievel			I <sub>OL</sub> = 8 mA	2.3	_	0.7	
	L-level	V <sub>OL</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 12 mA	2.7	_	0.4	
				I <sub>OL</sub> = 16 mA	3.0	_	0.4	
				I <sub>OL</sub> = 24 mA	3.0	_	0.55	
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μА
3-state output off-state	e current	I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$		1.65 to 3.6	_	±5.0	μА
Power off leakage cur	rent	I <sub>OFF</sub> V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V 0		V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		_	10.0	μА
Quiescent surely surely			V <sub>IN</sub> = V <sub>CC</sub> or GND		1.65 to 3.6	_	10.0	
Quiescent supply curr	Quiescent supply current $I_{CC}$ $V_{IN}/V_{OUT} = 3.6 \text{ to } 5.5 \text{ V}$		5.5 V	1.65 to 3.6	_	±10.0	μА	
Increase in I <sub>CC</sub> per in	out	Δl <sub>CC</sub>	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V		2.7 to 3.6	_	500	



#### AC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition V <sub>CC</sub> (V)		Min	Max	Unit
			1.8±0.15	_	25.0	
Dranagation dalay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.5±0.2	_	8.5	ns
Propagation delay time	t <sub>pHL</sub>	Figure 1, Figure 2	2.7	_	7.5	
			$3.3 \pm 0.3$	1.5	6.5	
			1.8±0.15	_	34.0	ns
Outside analysis there	$t_{pZL}$	t <sub>pZL</sub> t <sub>pZH</sub> Figure 1, Figure 3	2.5±0.2		17.0	
Output enable time	t <sub>pZH</sub>		2.7		9.5	
			$3.3\pm0.3$	1.5	8.5	
	t <sub>pLZ</sub>	Figure 1, Figure 3	1.8±0.15	_	32.0	
Output disable time			2.5±0.2	_	16.0	ns
Output disable time			2.7	_	8.5	115
			3.3 ± 0.3	1.5	7.5	
Output to output skew	t <sub>osLH</sub>	(Note)	2.7	-	_	ns
Output to output skew	t <sub>osHL</sub>	(Note)	$3.3 \pm 0.3$		1.0	119

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$ 

### Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500$ $\Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic $V_{OL}$	V <sub>OLP</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V

### **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_	3.3	7	pF
Output capacitance	C <sub>OUT</sub>	_	3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	f <sub>IN</sub> = 10 MHz (Note	) 3.3	40	pF

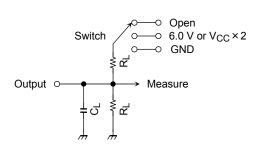
Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$ 



### **AC Test Circuit**



Parameter	Switch		
t <sub>pLH</sub> , t <sub>pHL</sub>	Open		
	6.0 V	@ V <sub>CC</sub> =3.3±0.3V	
t t	@ V <sub>CC</sub> =2.7V		
t <sub>pLZ</sub> , t <sub>pZL</sub>	V <sub>CC</sub> ×2	@ V <sub>CC</sub> =2.5±0.2V	
		@ V <sub>CC</sub> =1.8±0.15V	
t <sub>pHZ</sub> , t <sub>pZH</sub>		GND	

Figure 1

### **AC Waveform**

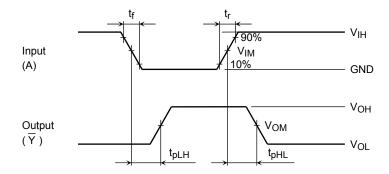


Figure 2  $t_{pLH}, t_{pHL}$ 

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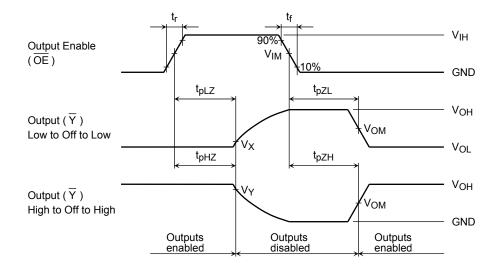


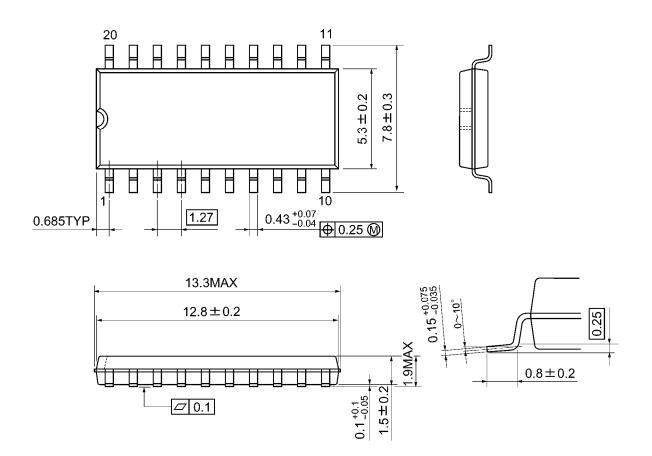
Figure 3  $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$ 

		Vcc					
	Symbol	$3.3 \pm 0.3  \text{V}$ $2.7 \text{V}$	$2.5\pm0.2\textrm{V}$	1.8 ± 0.15 V			
Input	V <sub>IH</sub>	2.7V	V <sub>CC</sub>	V <sub>CC</sub>			
	V <sub>IM</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2			
	t <sub>r</sub> , t <sub>f</sub>	2.5ns	2.0ns	2.0ns			
Output	V <sub>OM</sub>	1.5V	V <sub>OH</sub> /2	V <sub>OH</sub> /2			
	VX	V <sub>OL</sub> +0.3V	V <sub>OL</sub> +0.15V	V <sub>OL</sub> +0.15V			
	VY	V <sub>OH</sub> -0.3V	V <sub>OH</sub> -0.15V	V <sub>OH</sub> -0.15V			
Load	CL	50pF	30pF	30pF			
	RL	500Ω	500Ω	1kΩ			



## **Package Dimensions**

SOP20-P-300-1.27A Unit: mm

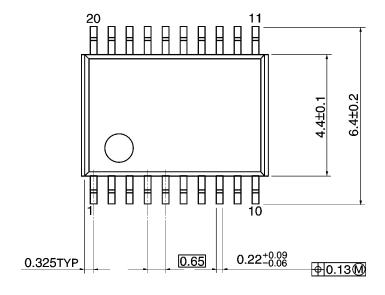


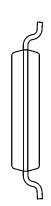
Weight: 0.22 g (typ.)

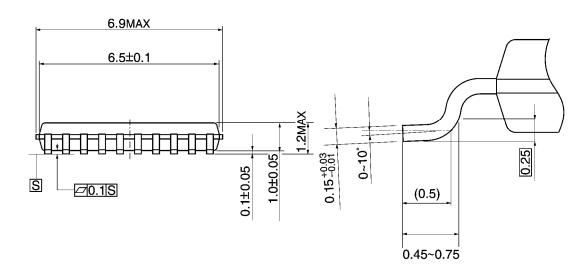
## **Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm





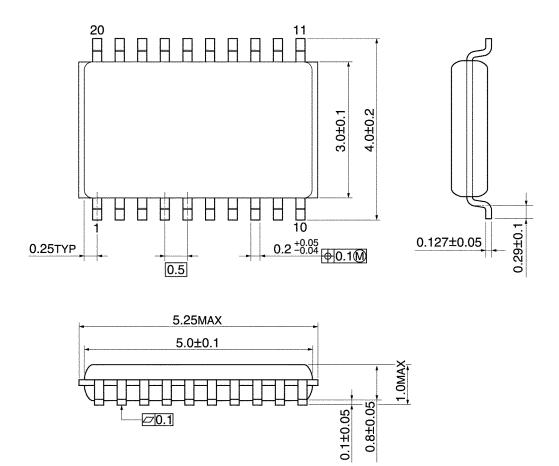


Weight: 0.08 g (typ.)



## **Package Dimensions**

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)

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